

**SPECIFICATION
OF
LCD MODULE**

MODULE NO.: HL101T33-01

Customer Approval:

☐ **Accept**

☐ **Reject**

	SIGNATURE	DATE
PREPARED BY		
CHECKED BY		
APPROVED BY		

DOCUMENT REVISION HISTORY

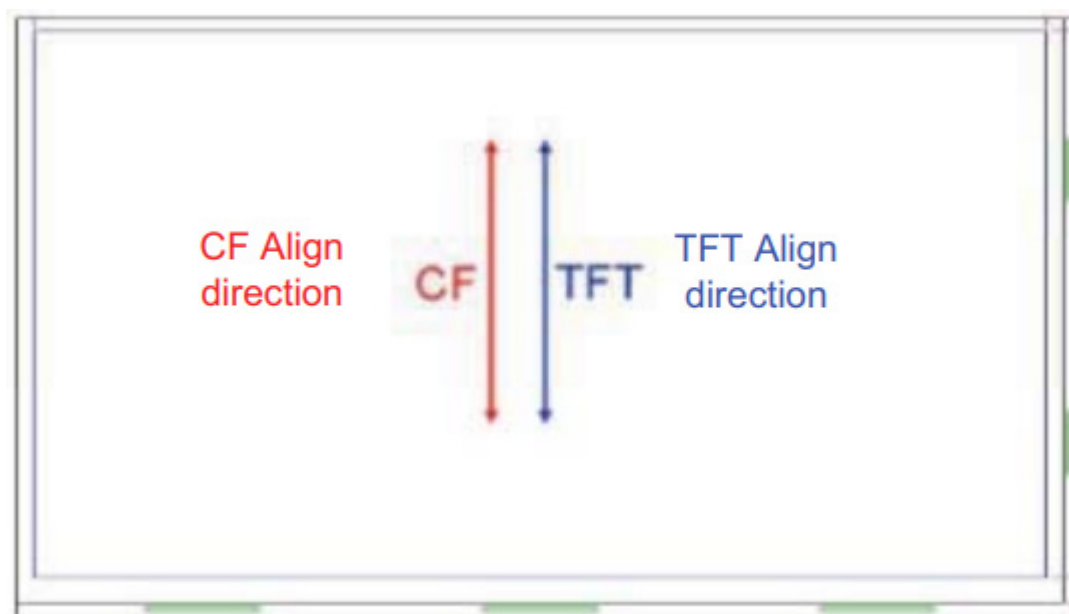
Sample Version	Doc. Version	DATE	DESCRIPTION	CHECKED BY
	A0	2025-10-15	First Release.	

1. MECHANICAL SPECIFICATIONS:

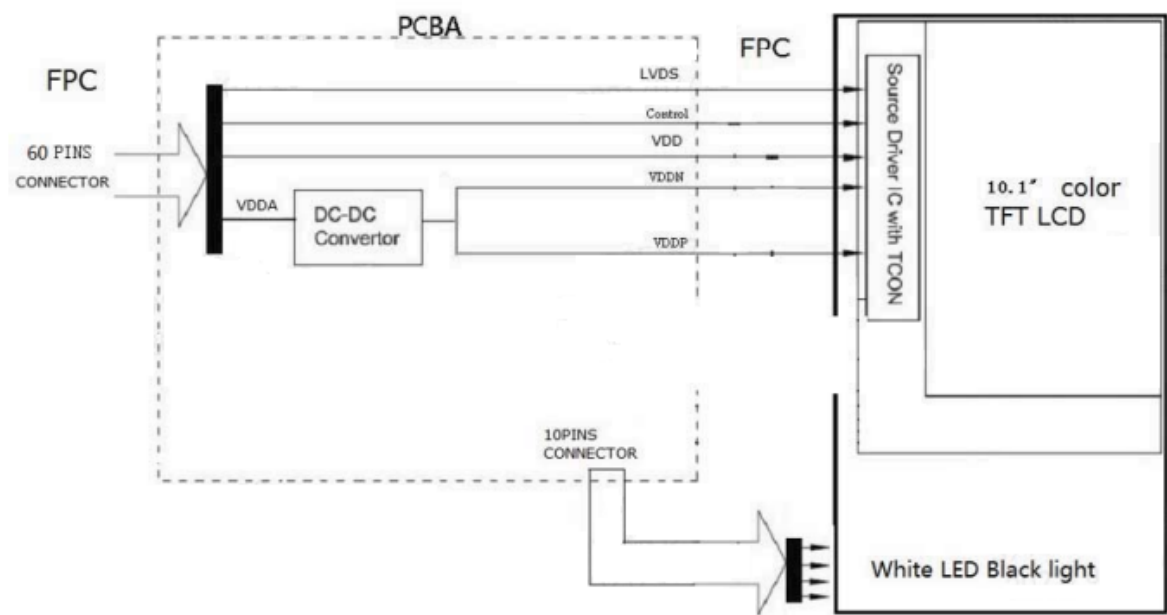
ITEM	SPECIFICATION	UNIT
OUTLINE DIMENSIONS	237.69(W) X142.7(H) X7.2 (D)	mm
DISPLAY SIZE	10.1	inch
ACTIVE AREA	223.488 X 125.712	mm
PIXEL PITCH	0.1164mmX0.1164mm	mm
NUMBER OF DOTS	1920* (RGB) *1080	-
LCD TYPE	16.7M display color by 8bit	-
BACKLIGHT TYPE	LED White	-
VIEWING DIRECTION	free	-
TOUCH PANEL	NONE	

***See attached drawing for details.**

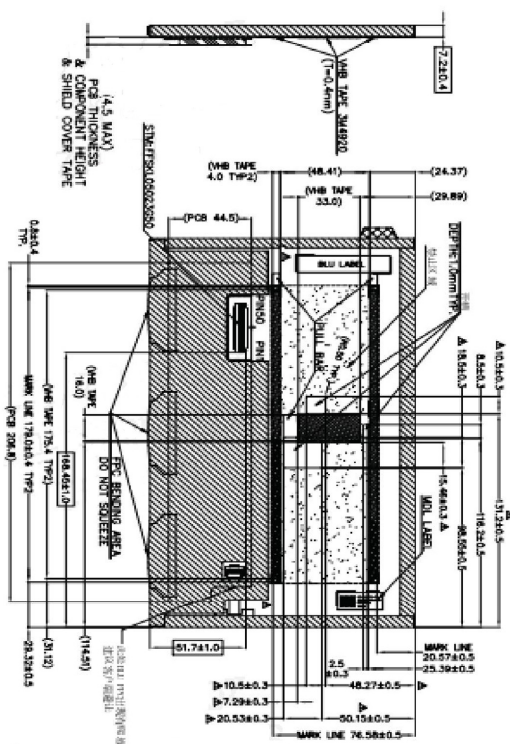
**** The TFT and CF align direction**



2.BLOCK DIAGRAM:



由 Autodesk 教育版产品制作



TITLE: LCM DIMENSION		REV. : 2.0		SCALE : -	
DESIGN					
CHECKED					
APPROVED					

(DOT SIZE FOR CUSTOMER
REFERENCE ONLY)

HL 海罗光电有限公司
Hello Lighting co.,LTD

HL101T33-01

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4. PIN DESCRIPTION:

NO.	PIN NAME	I/O	Description
1	VLED-	P	LED Cathode
2	VLED-	P	LED Cathode
3	VLED-	P	LED Cathode
4	VLED-	P	LED Cathode
5	NC	-	No connection
6	NTC1	P	NTC port1
7	NTC2	P	NTC port2
8	NC	-	No connection
9	VLED2+	I	LED anode2
10	VLED1+	P	LED anode1
11	GND	P	Power ground
12	OD0N	I	Odd data channel 0-
13	OD0P	I	Odd data channel 0+
14	GND	P	Power ground
15	OD1N	I	Odd data channel 1-
16	OD1P	I	Odd data channel 1+
17	GND	P	Power ground
18	OCLKN	I	Odd clock channel -
19	OCLKP	I	Odd clock channel +
20	GND	P	Power ground
21	OD2N	I	Odd data channel 2-
22	OD2P	I	Odd data channel 2+
23	GND	P	Power ground
24	OD3N	I	Odd data channel 3-
25	OD3P	I	Odd data channel 3+
26	GND	P	Power ground
27	ED0N	I	Even data channel 0-
28	ED0P	I	Even data channel 0+
29	GND	P	Power ground
30	ED1N	I	Even data channel 1-
31	ED1P	I	Even data channel 1+
32	GND	P	Power ground
33	ECLKN	I	Even clock channel -
34	ECLKP	I	Even clock channel +
35	GND	P	Power ground
36	ED2N	I	Even data channel 2-

37	ED2P	I	Even data channel 2+
38	GND	P	Power ground
39	ED3N	I	Even data channel 3-
40	ED3P	I	Even data channel 3+
41	GND	P	Power ground
42	VDDIN	P	Power supply VDDIN=3.3V (Typ.)
43	VDDIN	P	
44	ID1(GND)	P	ID1 output pin
45	ID2(GND)	P	ID2 output pin
46	RESET		Reset pin L: reset H: normal
47	STB		Standby pin L: standby mode H: normal mode
48	CS		Chip select, set to "1" when use
49	SCL		Serial clock, set to "0" when use
50	SDA		Serial data, set to "0" when use

Note:

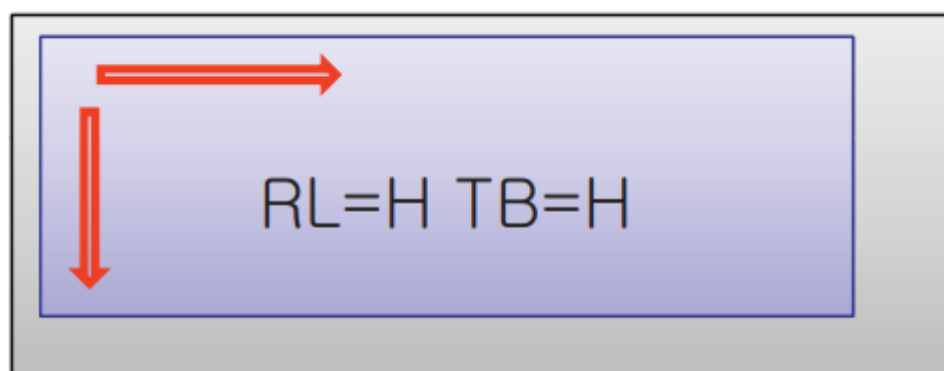
1.

I: host to LCD

O: LCD to host

P: power

2. scan direction



5. MAXIMUM ABSOLTE LIMIT:

Item	Symbol	Value	Unit
Power supply voltage for logic	DVDD	-0.3~3.96	V
Operating temperature	Topr	-40 to 85	°C
Operating humidity	RH	90	%
Storage temperature	Tstg	-40 to 90	°C
Storage humidity	RH	90	%

Note: Note1: Absolute maximum rating is the limit value beyond which the IC maybe broken.

They do not assure operations.

Note2: Background color changes slightly depending on ambient temperature. This Phenomenon is reversible.

Ta ≤ 70°C: 75%RH max

Ta > 70°C: absolute humidity must be lower than the humidity of 75%RH at 70°C

Note3: Ta at -30°C will be <48hrs, at 80 °C will be <120hrs

6.ELECTRICAL CHARACTERISTICS

6-1 DC Characteristics (Ta=25°C)

Parameter	Symbol	Values			Unit	Notes
		Min.	Typ.	Max.		
Power Supply Voltage	VDD	3.15	3.3	3.45	V	
Power Supply Current	IDD	-	220	330	mA	Note 1

6-2 Backlight Electrical-optical Characteristics

1. Stander Lamp Styles(Edge Lighting Type):

The LED chips are distributed over the edge light area of the illumination unit, which gives the less power consumption:

2. The Main Advantages of the LED Backlight are as following:

2.1 The brightness of the backlight can simply be adjusted by a resistor or a potentiometer.

3. Data About LED Backlight:

Item	Symbol	MIN	TYP	MAX	UNIT	Test Condition	Note
Supply Voltage	Vf	21.6	24	26.4	V		Per string
Supply Current	If	-	100	-	mA	-	Per string
Supply current(total)	IF		400		mA		
Life Time	-	30000	-	-	Hr		-
Backlight Color	White						

NOTE:

1. Average Luminous Intensity of P1-P9

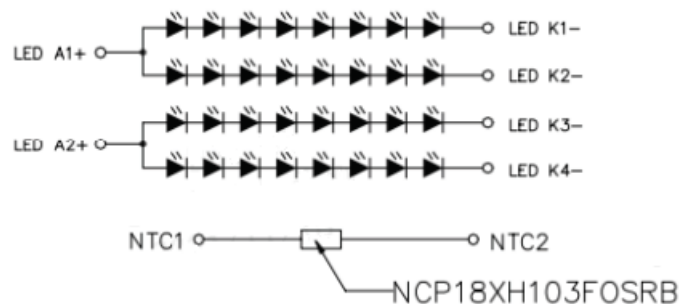
2. Uniformity = Min/Max * 100%

3.LED life time defined as follows: The final brightness is at 70% of original brightness

Measured Method: (X*Y: Light Area)(Left Draft as follow)

Internal Circuit Diagram(Right Draft as follow)

(Effective spatial Distribution)

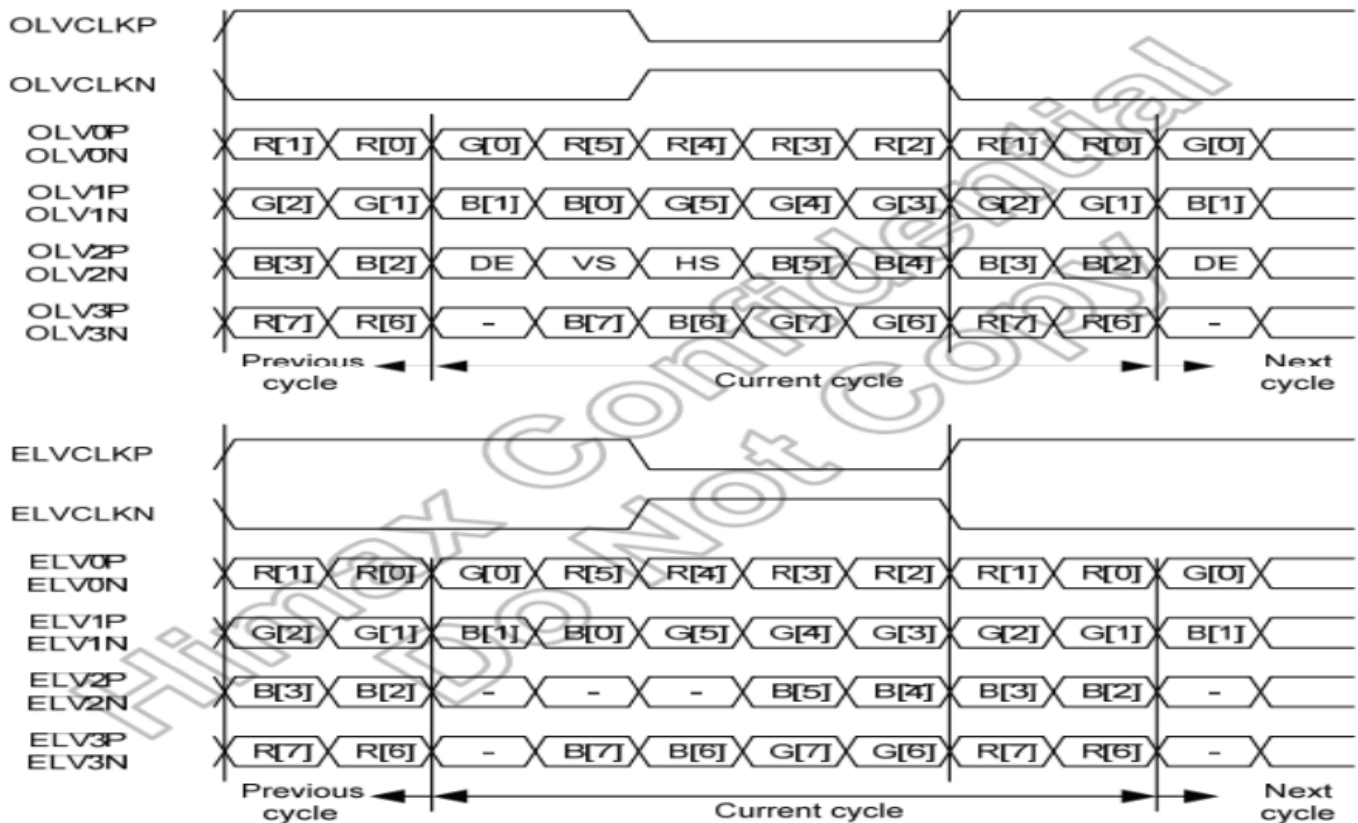


7.LVDS TIMING

7.1. LVDS signal timing

Symbol	Parameter	Conditions	Related Pins	Min.	Typ.	Max.	Unit
VP	Vertical Total	-	VSYNC	1087	1118	1404	Line
VS	VSYNC Low Pulse Width	-	VSYNC	1	3	20	Line
VBP	Vertical Back Porch	-	VSYNC	2	30	255	Line
VFP	Vertical Front Porch	-	VSYNC	5	8	260	Line
VDISP	Vertical Active Area	-	VSYNC	-	1080	-	Line
HP	Horizontal Total	-	HSYNC	989	1002	1248	DCK
HS	HSYNC Low Pulse Width	-	HSYNC	10	12	255	DCK
HBP	Horizontal Back Porch	-	HSYNC	5	16	255	DCK
HFP	Horizontal Front Porch	-	HSYNC	24	26	260	DCK
HDISP	Horizontal Active Area	Display mode-	HSYNC	-	960	-	DCK
F _{frame}	Frame Frequency	-	CLK	-	60	-	Hz
f _{CLK}	CLK frequency	-	CLK	64.5	67.2	85	MHz

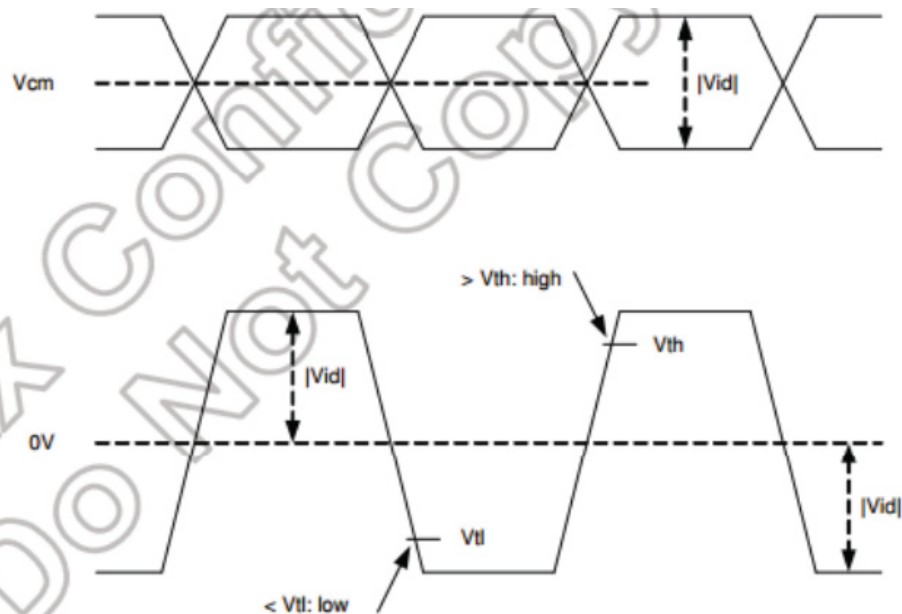
7.2. Signal format



7.3. LVDS DC characteristics

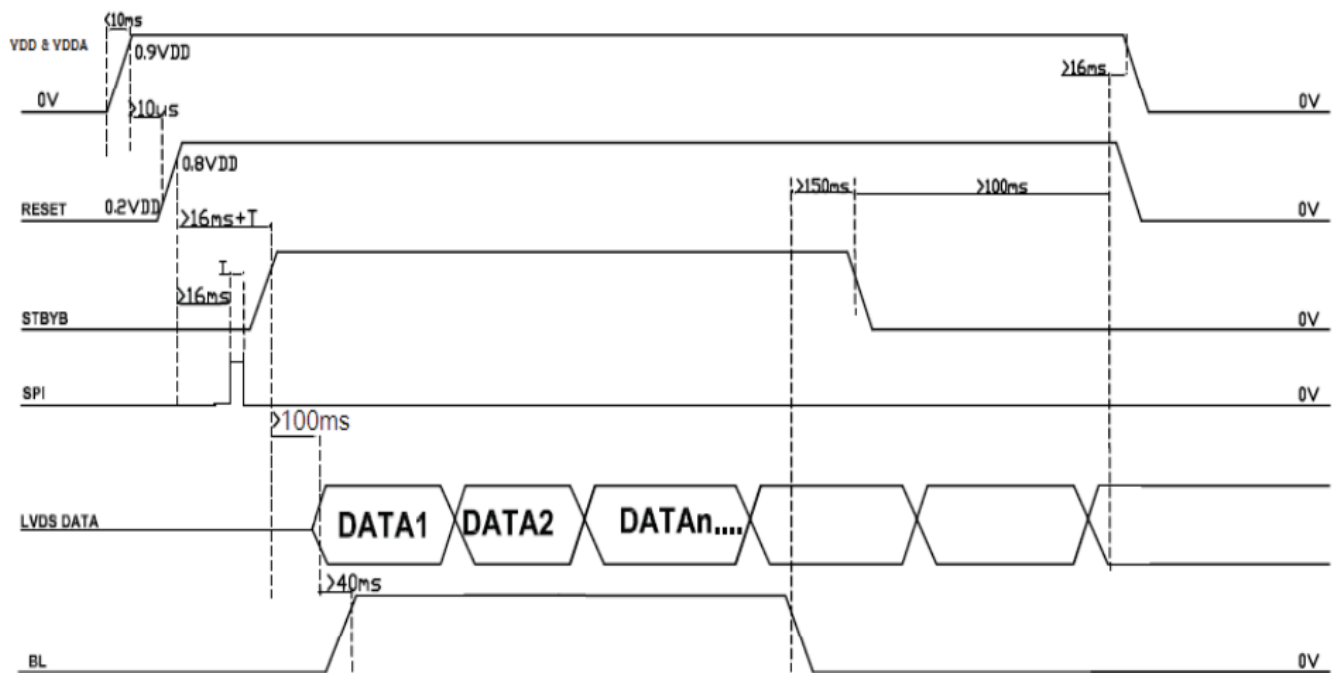
Parameter	Symbol	Min.	Spec. Typ.	Max.	Unit	Condition
Differential input high Threshold voltage	V _{th}	+0.1	-	-	V	V _{cm} =1.2V
Differential input low threshold voltage	V _{tl}	-	-	-0.1	V	
Differential input common Mode voltage	V _{CM}	1	1.2	1.7- V _{id} /2	V	-
LVDS input voltage	V _{INLV}	0.7		1.7	V	
Differential input voltage	V _{id}	0.2	-	0.6	V	-
Differential input leakage Current	I _{lvleak}	-10	-	+10	μA	-

Single-ended:
LVCLKP(R),
LVCLKN(R),
LVD[3:0]P(R),
LVD[3:0]N(R)



Note: AC and DC characteristics of the above LVDS is an acceptable specification for the driver IC, and the system output specification needs to be tested and validated with the entire module to meet the IC requirements.

7.4. Power sequence



8. OPTICAL CHARACTERISTICS:

Driving the backlight

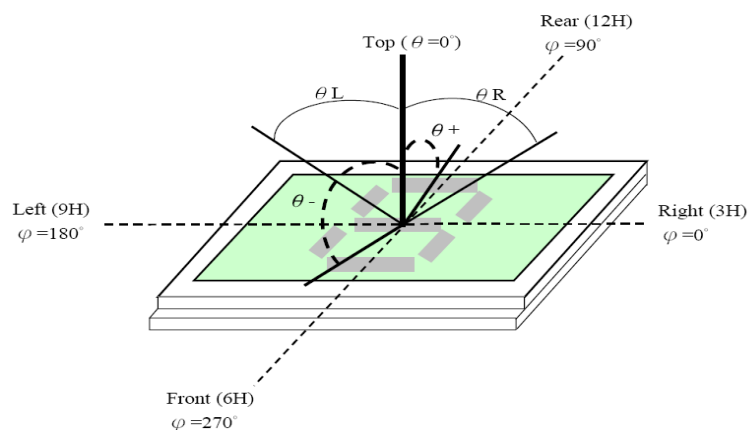
No.	ITEM		Symbol	Conditions	Specification			Unit	Note
					Min	Typ	Max		
1	Response Time		Tr+Tf	25℃	-	30	40	ms	(1)(2)
				-30℃	-	600	700	ms	
2	Contrast Rate		Cr	θ=0, Normal viewing angle	800	1000	-	-	(1)(3)
3	Viewing Angle	Hor.	θL	CR>10	-	85	-	Deg	-
			θR		-	85	-		
		Ver.	Θ+		-	85	-		
			Θ-		-	85	-		
4	Chromaticiry	White	x	Brightness is ON	0.275	0.305	0.335		
			y		0.319	0.349	0.379		
5	luminance		L		800	1000		cd/m2	
6	Uniformity		U		80			%	
7	NTSC				70	80		%	
8	Gamma				1.9	2.2	2.5		25℃
9	Crosstalk						2%		25℃

Measure Conditions:

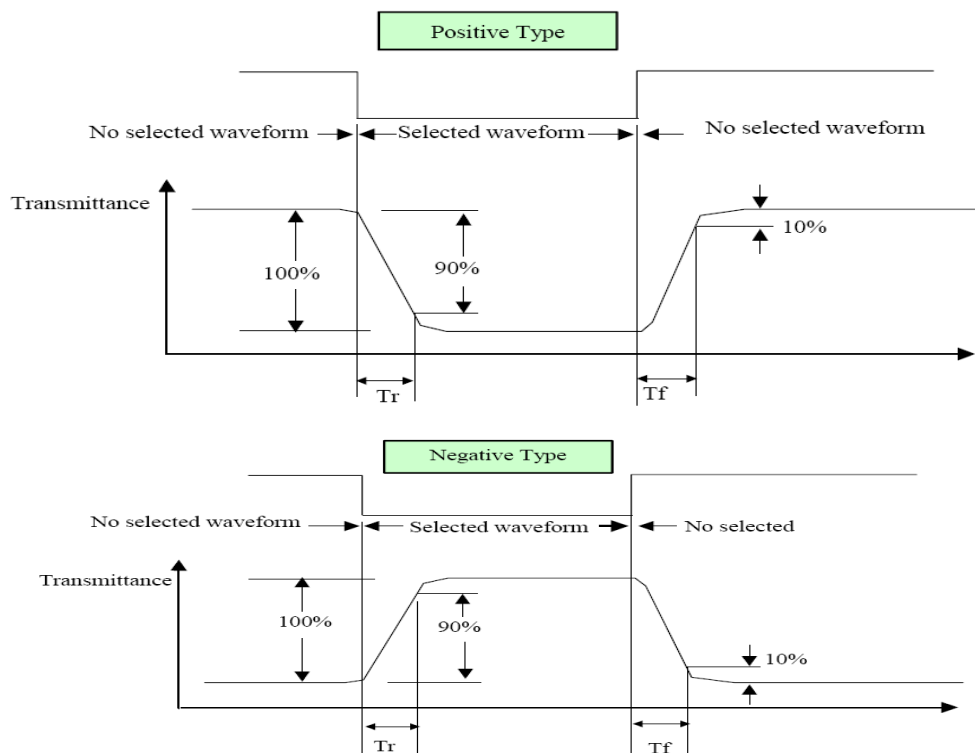
1. Measure surrounding : dark room;
2. Ambient temperature: $25\pm 2^\circ\text{C}$;
3. 30min.warm-up time.

Note Definition:

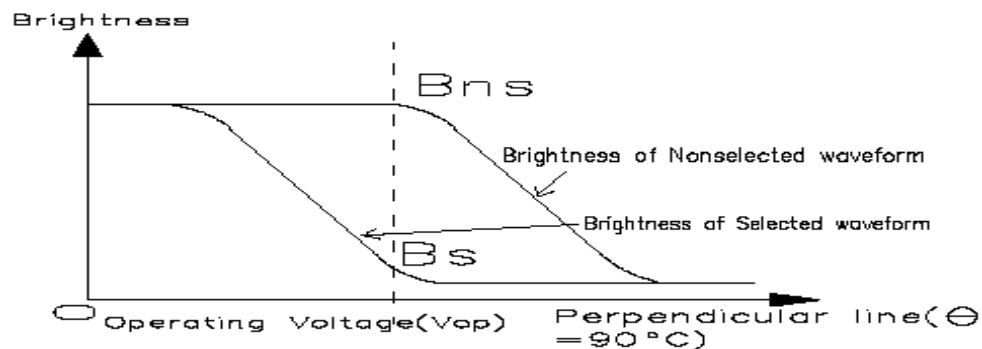
Note(1)Viewing angle range:



Note(2) Response Time:

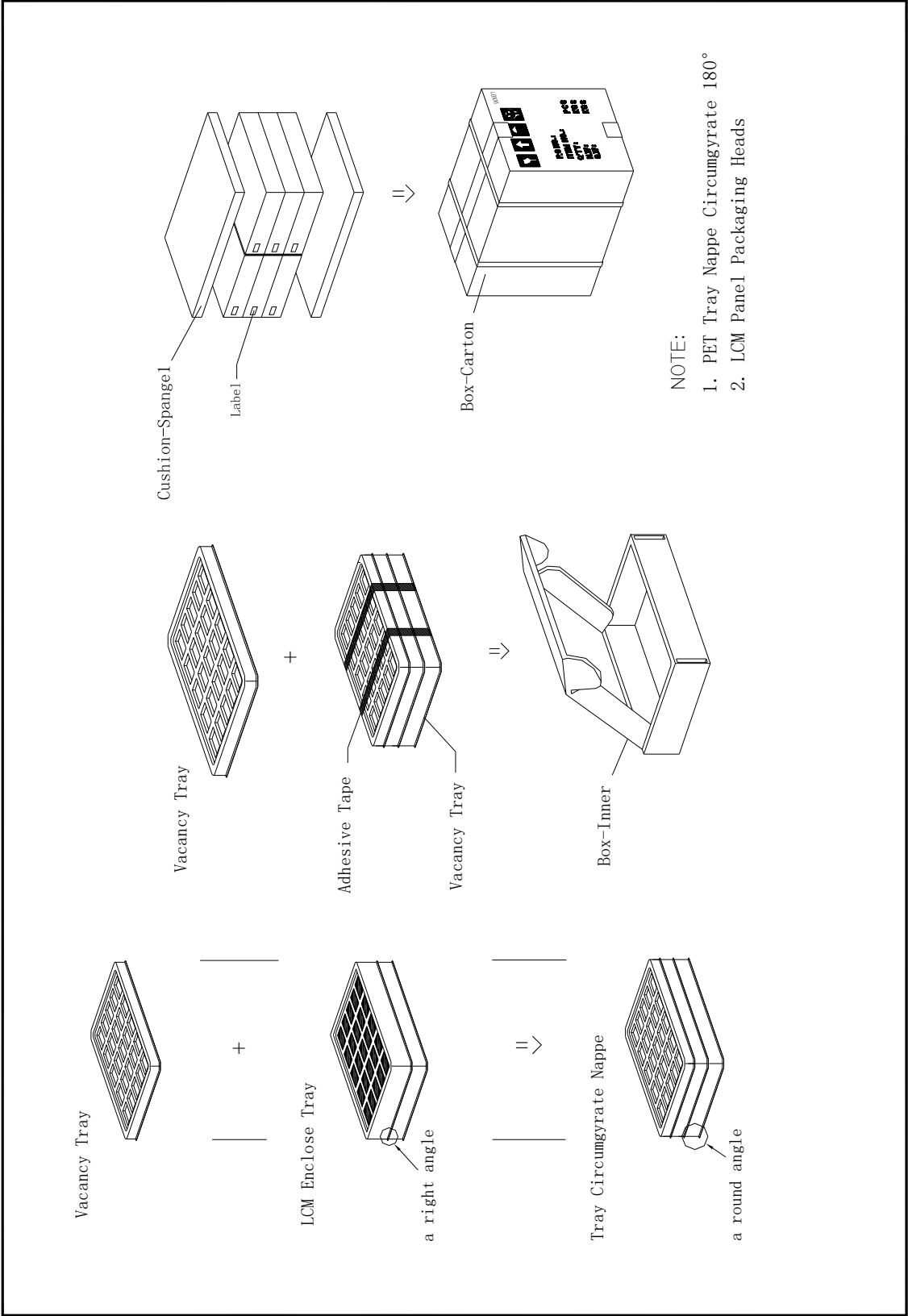


Note(3) Contrast Ratio Definition:



$$\text{Contrast Ratio (Cr)} = \frac{\text{Luminance with all pixel white}}{\text{Luminance with all pixel black}}$$

9.PACKAGE.



10. STANDARD SPECIFICATION FOR RELIABILITY:

Item	Condition	Time (hrs)	Assessment
High temp. Storage	90°C	480	No abnormalities in functions and appearance
High temp. Operating	85°C	480	
Low temp. Storage	-40°C	480	
Low temp. Operating	-40°C	480	
Humidity, operation	60°C/ 95%RH	480	
Thermal Shock Temp. Cycle, non-operation	-40°C ← → 85°C (20min ← → 20min)	300cycles	
Sun radiation	1000w/m ² 42°C,100hour, <30%Rh, With Xenon lamp, power off		
ESD test	Air voltage : ± 8kv & ± 15kv Contact voltage: ± 8kv R:330 Ω ,159pF 5times		
Shock Test non-operation	3 direction: X Y Z axes Repeats:6 Peak acc:100G Pulse duration:6ms(half sine wave) Non-operation		

Vibration Test(Non-operation)	3directions: X,Y,Z axes Sweep time: 10(1Oct/min) Frequency acc.: 10-150-10Hz 10~58Hz : constant amplitude 0.75peak 58~150Hz: constant acceleration 10gpeak Sinusoidal, Non-Operating		
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Functions, performance, appearance, etc. shall be free from remarkable deterioration within 50,000 hours under ordinary operating and storage conditions room temperature ($25\pm 10^{\circ}\text{C}$), normal humidity ($45\pm 20\%$ RH), and in area not exposed to direct sun light. (Life time of backlight, please refer to Data about backlight.)

Testing Conditions and Inspection Criteria:

For the final test the testing sample must be stored at room temperature for 24 hours, after the tests listed in up Table, Standard specifications for Reliability have been executed in order to ensure stability.

Item	Test Model	In section Criteria
Current Consumption	Refer To Specification	The current consumption should conform to the product specification.
Contrast	Refer To Specification	After the tests have been executed, the contrast must be larger than half of its initial value prior to the tests.
Appearance	Visual inspection	Defect free.

11.SPECIFICATION OF QUALITY ASSURANCE:

11.1 Purpose

This standard for Quality Assurance should affirm the quality of LCD Module products to supply to purchaser.

11.2 Standard for Quality Test

a. Inspection:

Before delivering, the supplier should take the following tests, and affirm the quality of product.

b. Electro-Optical Characteristics:

According to the individual specification to test the product.

c. Test of Appearance Characteristics:

According to the individual specification to test the product.

d. Test of Reliability Characteristics:

According to the definition of reliability on the specification for testing products.

e. Delivery Test:

Before delivering, the supplier should take the delivery test.

(i) Test method: According to MIL-STD105E.General Inspection Level II take a single time.

(ii) The defects classify of AQL as following:

Major defect: AQL = 0.65

Minor defect: AQL = 2.5

Total defects: AQL = 2.5

11.3. Nonconforming Analysis & Deal With Manners

a. Nonconforming Analysis:

(i) Purchaser should supply the detail data of non- conforming sample and the non- conforming.

(ii) After accepting the detail data from purchaser, the analysis of nonconforming should be finished in two weeks.

(iii) If supplier can not finish analysis on time, must announce purchaser before two weeks.

b. Disposition of nonconforming:

(i) If find any product defect of supplier during assembly time, supplier must change the good product for every defect after recognition.

(ii) Both supplier and customer should analyze the reason and discuss the disposition of nonconforming when the reason of nonconforming is not sure.

11.4. Agreement items

Both sides should discuss together when the following problems happen.

a. There is any problem of standard of quality assurance, and both sides think that it must be modified.

b. There is any argument item which does not record in the standard of quality assurance.

c. Any other special problem.

11.5 Standard of The Product Appearance Test

a. Manner of appearance test: This specification should be applied for both light on and off situation.

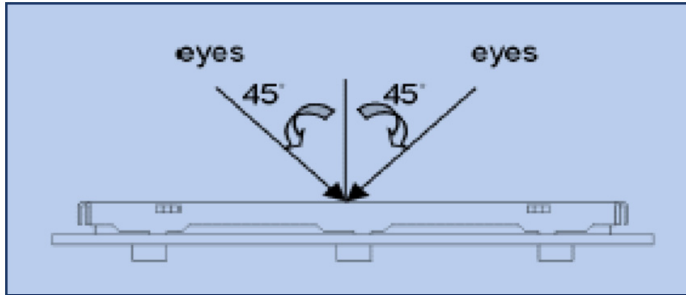
(i) The test must be under 20W × 2 or 40W fluorescent light, and the distance of view must

be at 30 ± 5 cm.

(ii) When test the model of transmissive product must add the reflective plate.

(iii) The test direction is base on about around 10° of vertical line (Left graph)

(iii) Temperature: $25 \pm 5^\circ\text{C}$ Humidity: $65 \pm 10\%\text{RH}$



(iv) Definition of area (Right graph)

A. Area: Viewing area. B. Area: Out of viewing area.(Outside viewing area)

b. Basic principle:

(i) It will accord to the AQL when the standard can not be described.

(ii) The sample of the lowest acceptable quality level must be discussed by both supplier and customer when any dispute happened.

(iii) Must add new item on time when it is necessary.

c. Standard of inspection: (Unit: mm)

Allowable limits defined in follow Dot defect Table should be met for each white, black , R, G, B raster. The limits apply to the entire area. Missing white in 60% or more of typical (one color, R or G or B) pixel aperture is defined as a bright defect, less than 60% is acceptable .Black spot in 60% or more of typical pixel aperture is defined as a dark defect, less than 60% is acceptable.

Dot defect table:

Item		White dot defect	Black dot defect	Total
1	Defect counts	3	3	3
2	Combined defect Counts	No combined dot defect allowed. Two Single dot defect that within 5mm during each dot defect should be counted as combined dot defect.		

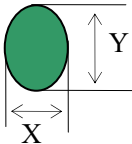
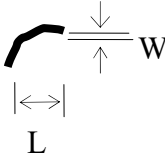
11.6 Inspection specification

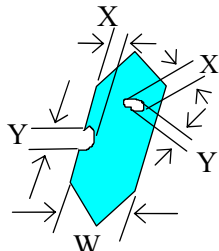
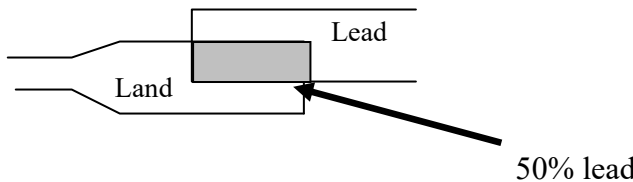
AQL inspection standard

Sampling method: MIL-STD-105E, Level II, single sampling

Classify	Item		Note	AQL	
Major	Display state	Short or open circuit	1	0.65	
		Contrast defect (dim, ghost)			
		LC leakage			
		Flickering			
		No display			
		Wrong viewing direction	2		
		Wrong Back-light	7		
	Non-display	Flat cable or pin reverse	9		
		Wrong or missing component	10		
Minor	Display state	Background color deviation	2	2.5	
		Black spot and dust	3		
		Line defect	4		
		Scratch			
		Rainbow	5		
		Pin hole	6		
	Polarizer	Bubble and foreign material	3		
		Scratch	4		
	PCB,FPC	Scratch	4		
	Soldering	Poor connection	8		
	Wire	Poor connection	9		
	LCD	CHIP OUT	11		

Note on defect classification:

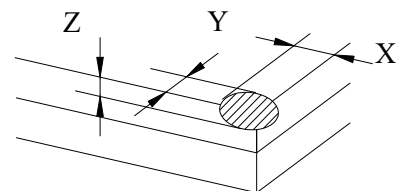
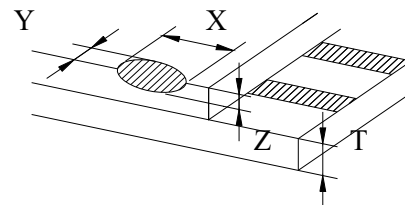
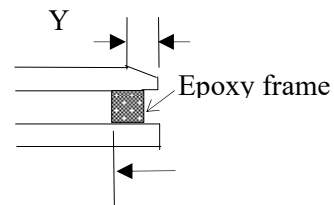
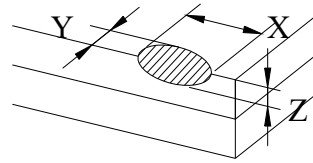
No.	Item	Criterion																				
1	Short or open circuit	Not allow																				
	LC leakage																					
	Flickering																					
	No display																					
	Wrong viewing direction																					
	Wrong Back-light																					
2	Contrast defect	Refer to approval sample																				
	Background color deviation																					
3	Point defect, Black spot, dust (incl. Polarizer) ex.: dirt under polarizer, Pinhole of reflector ,glass scratch, dirt under glass,scratch on polarizer $\phi = (X+Y)/2$	 <table><tr><td>Point</td><td>Acceptable Qty.</td></tr><tr><td>Size</td><td></td></tr><tr><td>$\phi \leq 0.20$</td><td>Disregard</td></tr><tr><td>$0.20 < \phi \leq 0.25$</td><td>3</td></tr><tr><td>$0.25 < \phi \leq 0.30$</td><td>2</td></tr><tr><td>$\phi > 0.30$</td><td>0</td></tr></table> Unit: mm	Point	Acceptable Qty.	Size		$\phi \leq 0.20$	Disregard	$0.20 < \phi \leq 0.25$	3	$0.25 < \phi \leq 0.30$	2	$\phi > 0.30$	0								
Point	Acceptable Qty.																					
Size																						
$\phi \leq 0.20$	Disregard																					
$0.20 < \phi \leq 0.25$	3																					
$0.25 < \phi \leq 0.30$	2																					
$\phi > 0.30$	0																					
4	Line defect	 <table><tr><td></td><td>Line</td><td>Acceptable Qty.</td></tr><tr><td>L</td><td>W</td><td></td></tr><tr><td>---</td><td>$0.015 \geq W$</td><td>Disregard</td></tr><tr><td>$3.0 \geq L$</td><td>$0.03 \geq W$</td><td rowspan="2">2</td></tr><tr><td>$2.0 \geq L$</td><td>$0.05 \geq W$</td></tr><tr><td>$1.0 \geq L$</td><td>$0.1 > W$</td><td>1</td></tr><tr><td>---</td><td>$0.05 < W$</td><td>Applied as point defect</td></tr></table> Unit: mm		Line	Acceptable Qty.	L	W		---	$0.015 \geq W$	Disregard	$3.0 \geq L$	$0.03 \geq W$	2	$2.0 \geq L$	$0.05 \geq W$	$1.0 \geq L$	$0.1 > W$	1	---	$0.05 < W$	Applied as point defect
	Line	Acceptable Qty.																				
L	W																					
---	$0.015 \geq W$	Disregard																				
$3.0 \geq L$	$0.03 \geq W$	2																				
$2.0 \geq L$	$0.05 \geq W$																					
$1.0 \geq L$	$0.1 > W$	1																				
---	$0.05 < W$	Applied as point defect																				
5	Rainbow	Not more than two color changes across the viewing area																				

No.	Item	Criterion								
6	Segment pattern W = Segment width $\phi = (X+Y)/2$	(1) Pin hole $\phi < 0.10\text{mm}$ is acceptable.  <table><tr><th>Point Size</th><th>Acceptable Qty</th></tr><tr><td>$\phi \leq 1/4W$</td><td>Disregard</td></tr><tr><td>$1/4W < \phi \leq 1/2W$</td><td>1</td></tr><tr><td>$\phi > 1/2W$</td><td>0</td></tr></table> Unit: mm	Point Size	Acceptable Qty	$\phi \leq 1/4W$	Disregard	$1/4W < \phi \leq 1/2W$	1	$\phi > 1/2W$	0
Point Size	Acceptable Qty									
$\phi \leq 1/4W$	Disregard									
$1/4W < \phi \leq 1/2W$	1									
$\phi > 1/2W$	0									
7	Back-light	(1) The color of backlight should correspond its specification. (2) Not allow flickering								
8	Soldering	(1) Not allow heavy dirty and solder ball on PCB or FPC. (The size of dirty refer to point and dust defect) (2) Over 50% of lead should be soldered on Land. 								
9	Wire	(1) Copper wire should not be rusted (2) Not allow crack on copper wire connection. (3) Not allow reversing the position of the flat cable. (4) Not allow exposed copper wire inside the flat cable.								
10	PCB,FPC	(1) Not allow screw rust or damage. (2) Not allow missing or wrong putting of component.								

11

LCD

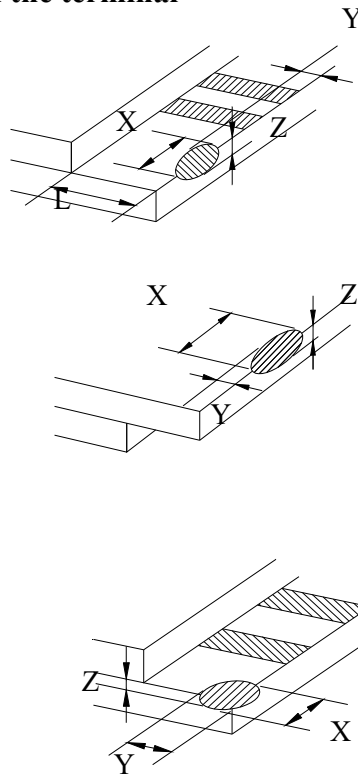
2.1.1 chip on the surface



Note: A: LCD Length

X	Y	Z
$>1/8A$	$\leq 0.3\text{mm}$	$\leq 1/2T$
$\leq 1/8A$	Not enter into epoxy frame	$\leq T$
	Not enter into the inner edge of epoxy	$\leq 1/2T$

2.1.2 Chip on the terminal

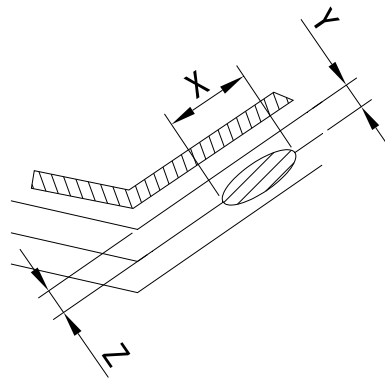


X	Y	Z
$>1/8A$	$\leq 0.3\text{mm}$	$\leq 1/2T$
$\leq 1/8A$	$\leq 1/2L$	$\leq T$
$\leq 1/8A \& \leq 1\text{mm}$	$\leq L$	$\leq T$
$\leq 1/8A \& \leq 2\text{mm}$	$\leq L$	$\leq 1/2T$

Note: A: LCD Length.

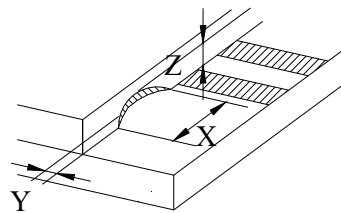
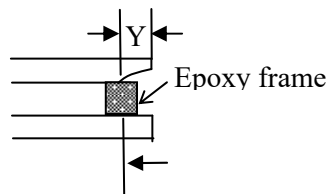
the distance between crack and contact pad must be greater than the width of 1st contact pad.

2.1.3 Chip out on between side



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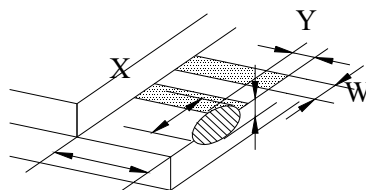
LCD



X	Y	Z
$\leq 1/8A$	Not enter into epoxy frame	$Z \leq 2T$
	Not enter into 1/2 epoxy frame	$Z \leq 1/2T$

Note: A : LCD Length

2.1.4 including corner chip and side chip

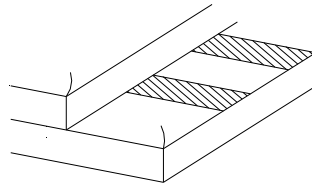


L

Note: A:LCD Length

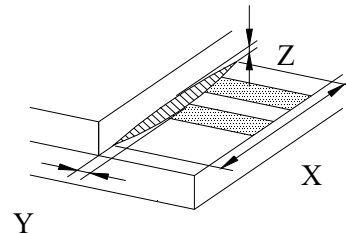
X	Y	Z
$> 1/8A$	$\leq 1/6L$	$\leq 1/2T$
$\leq 1/8A$	$\leq 1/3L$	
$\leq 1/4W$	$\leq 2/3L$	

2.2 Chip out



- 1) Chip out is that crackles extend to inner edge.
- 2) Crackles round epoxy frame will be rejected.
- 3) Chip out on the terminal will be rejected: $Z=T$ length $>1\text{mm}$ or $Z<T$ length $>2\text{mm}$
- 4) The chip out at ITO will be rejected.

2.3 Poor cutting



X	Y	Z
$>1/8$ A	≤ 0.3	$\leq 1/2T$
$\leq 1/8$ A	According to drawing	$1/2T \leq Z \leq T$

Note : A: LCD Length.

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LCD

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SMT

According to the <Acceptable of electronic assemblies>
IPC-A-610C class 2 stander. Component missing or function defect
are Major defect ,the others are Minor defect.

Any one out of the specification will be rejected.

12. GENERAL PRECAUTIONS

(1) Mounting Method

The panel of the LCD Module consists of two thin glass plates with polarizers which easily get damaged since the Module is fixed by utilizing fitting holes in the printed circuit board. Extreme care should be taken when handling the LCD Modules.

(2) Caution of LCD handling & cleaning

When cleaning the display surface, use soft cloth with solvent (recommended below) and wipe lightly.

- Isopropyl alcohol
- Ethyl alcohol
- Trichlorotrifluoroethane

Do not wipe the display surface with dry or hard materials that will damage the polarizer surface. Do not use the following solvent:

- Water
- Ketone
- Aromatics

(3) Caution against static charge

The LCD Module use C-MOS LSI drivers, so we recommend that you connect any unused input terminal to VDD or VSS, do not input any signals before power is turned on. And ground your body, Work/assembly table. And assembly equipment to protect against static electricity.

(4) Packaging

Modules use LCD elements, and must be treated as such. Avoid intense shock and falls from a height.

- To prevent modules from degradation. Do not operate or store them exposed directly to sunshine or high temperature/humidity.

(5) Caution for operation

- It is indispensable to drive LCD's within the specified voltage limit since the higher voltage than the limit shorten LCD life. An electrochemical reaction due to direct current causes LCD deterioration, Avoid the use of direct current drive.
- Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them.

However those phenomena do not mean malfunction or out of order with LCD's which will come back in the specified operating temperature range.

- If the display area is pushed hard during operation, some font will be abnormally displayed but it resumes normal condition after turning off once.
- As light dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal

open circuit.

Usage under the relative condition of 40°C, 50%RH or less is required.

(6) Storage

In the case of storing for a long period of time (for instance, for years) for the purpose or replacement use, The following ways are recommended.

- Storage in a polyethylene bag with sealed so as not to enter fresh air outside in it, And with no desiccant.
- Placing in a dark place where neither exposure to direct sunlight nor light is.

Keeping temperature in the specified storage temperature range.

- Storing with no touch on polarizer surface by the anything else. (It is recommended to store them as they have been contained in the inner container at the time of delivery)

(7) Safety

- It is recommendable to crash damaged or unnecessary LCD into pieces and wash off liquid crystal by using solvents such as acetone and ethanol which should be burned up later.
- When any liquid crystal leaked out of a damaged glass cell comes in contact with your hands, please wash it off well with soap and water.

Hello Lighting co., ltd reserves the right to change this specification.

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- END -